Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Forward Voltage	@ I_F = 10mA	V_F	0.9	V

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 5)	P_D	200	mW
Thermal Resistance, Junction to Ambient Air	(Note 5)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range		T_J, T_{STG}	-65 to +150	°C

Note: 5. Device mounted on FR-4 PC board with recommended pad layout which can be found on our website at http://www.diodes.com/package-outlines.html.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Type Number	Marking Code	Zener Voltage Range (Note 6)			Maximum Zener Impedance (Note 7)			Maximum Reverse Current (Note 8)	
		$V_{Z\ @\ I_{ZT}}$		I_{ZT}	Z_{ZT} @ I_{ZT}	Z_{ZK} @ I_{ZK}	I_{ZK}	I_R	@ V_R
		Min (V)	Max (V)	mA	Ω		mA	µA	V
DDZ5V1BS	KM	4.94	5.20	20	17	480	1	5	1.5
DDZ5V6BS	KN	5.45	5.73	20	11	400	1	0.5	2.5
DDZ6V2BS	KO	5.96	6.27	20	7	150	1	0.5	4.0
DDZ6V8CS	YP	6.66	7.01	20	5	150	0.5	0.5	5.0
DDZ7V5CS	YQ	7.29	7.67	20	6	120	0.5	0.5	6.0
DDZ8V2CS	YR	8.03	8.45	20	8	120	0.5	0.5	6.5
DDZ9V1CS	YS	8.83	9.30	20	8	120	0.5	0.5	7.0
DDZ10CS	YT	9.70	10.20	20	8	120	0.5	0.1	8.0
DDZ11CS	YU	10.82	11.38	10	10	120	0.5	0.1	8.4
DDZ12CS	YV	11.74	12.35	10	12	110	0.5	0.1	9.1
DDZ13BS	KW	12.55	13.21	10	14	110	0.5	0.1	10.0
DDZ14S	GX	13.65	14.35	10	16	110	0.5	0.05	11.0
DDZ15S	GY	14.80	15.57	10	18	150	0.5	0.05	12.0
DDZ16S	YY	15.69	16.51	10	18	150	0.5	0.05	12.0
DDZ18CS	YZ	17.42	18.33	10	23	150	0.5	0.05	14.0
DDZ20CS	PJ	19.23	20.22	10	28	200	0.5	0.05	15.0
DDZ22DS	2K	21.52	22.63	5	30	200	0.5	0.05	17.0
DDZ24CS	PL	23.12	24.31	5	35	200	0.5	0.05	19.0
DDZ27DS	2M	26.29	27.64	5	45	250	0.5	0.05	21.0
DDZ30DS	2N	29.02	30.51	5	55	250	0.5	0.05	23.0
DDZ33S	RP	32.14	33.79	5	75	250	0.5	0.05	27.0
DDZ36S	ZQ	35.36	37.19	5	85	250	0.5	0.05	30.0
DDZ39FS	5Q	38.02	39.98	5	85	250	0.5	0.05	30.0
DDZ43S	ZR	42.14	43.86	5	90	—	—	0.05	33.0
DDZ47S	ZS	46.06	47.94	5	90	—	—	0.05	36.0

Notes: 6. The Zener voltage is measured <40ms after power is supplied.
7. f = 1kHz.
8. Short duration pulse test used to minimize self-heating effect.

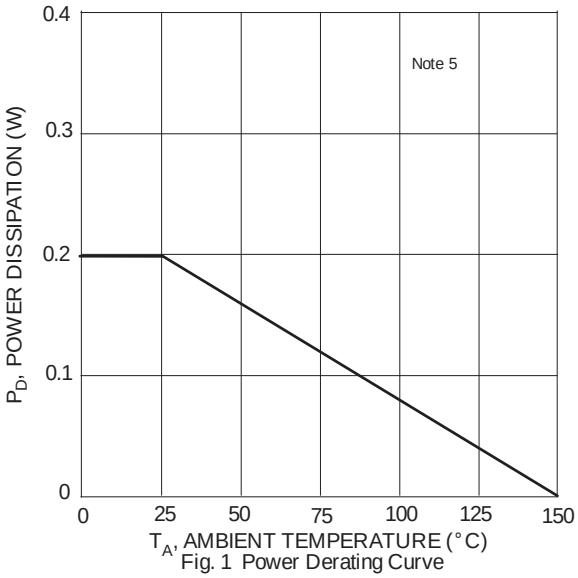


Fig. 1 Power Derating Curve

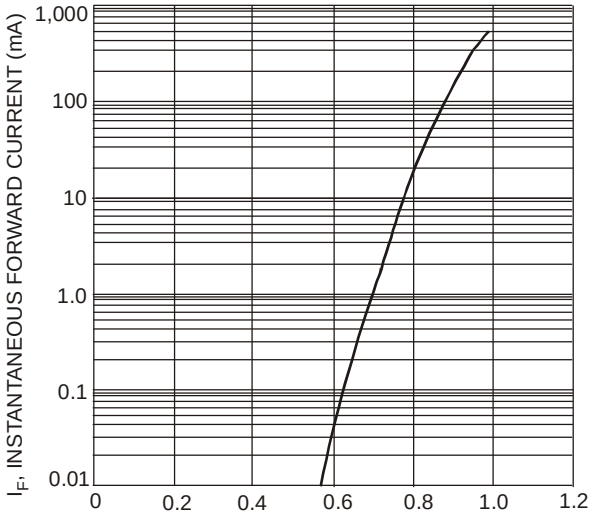


Fig. 2 Typical Forward Characteristics

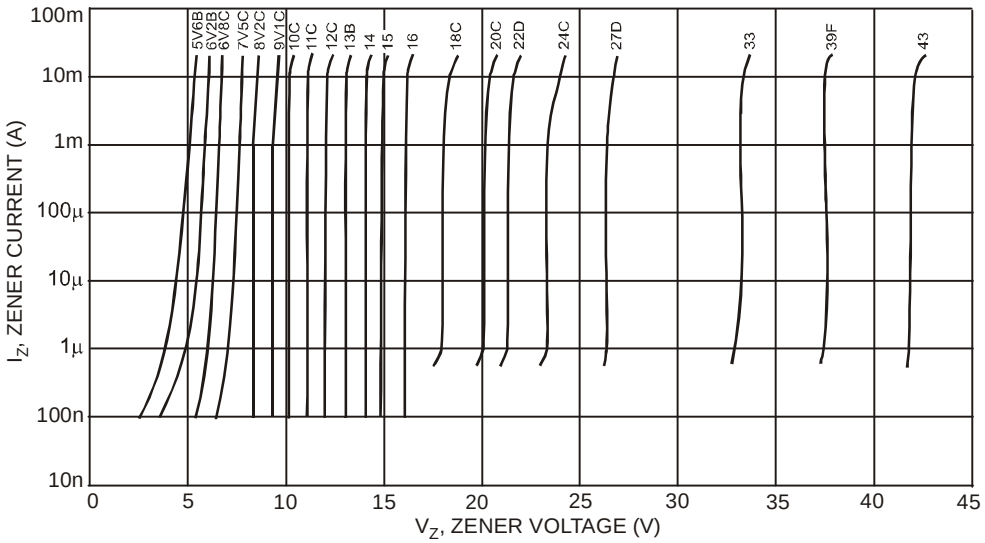


Fig. 3 Typical Zener Breakdown Characteristics

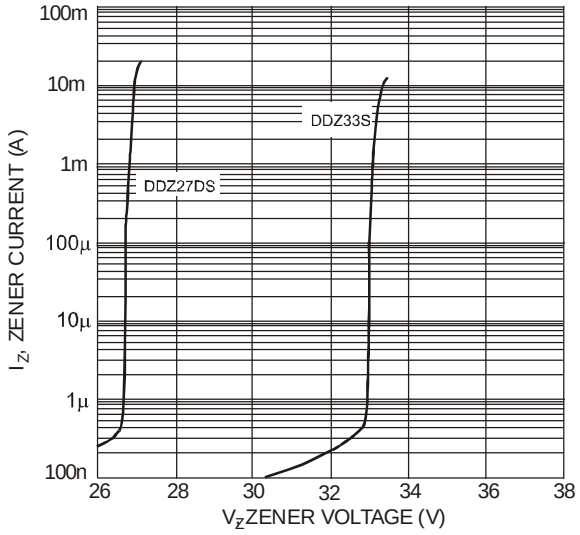


Fig. 4 Typical Zener Breakdown Characteristics, DDZ27DS - DDZ33S

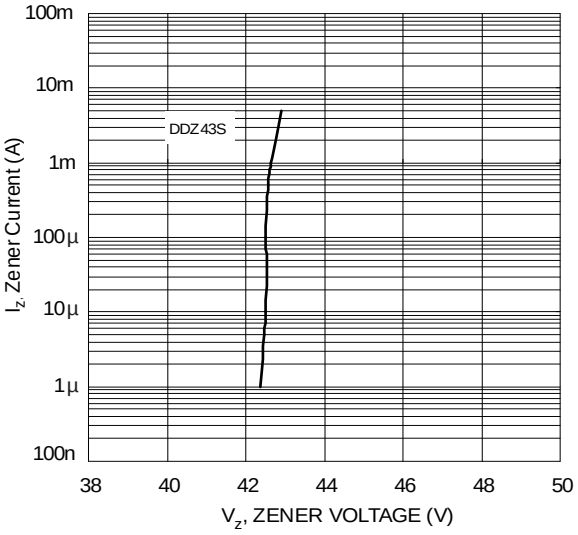


Fig.5 Typical Zener Breakdown Characteristics DDZ43S

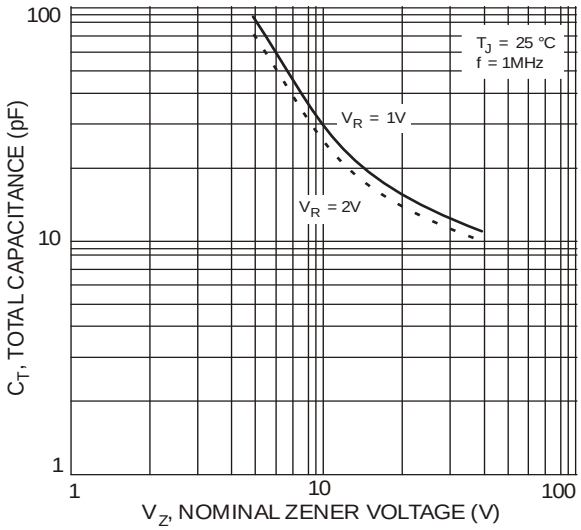


Fig. 6 Typical Total Capacitance vs. Nominal Zener Voltage

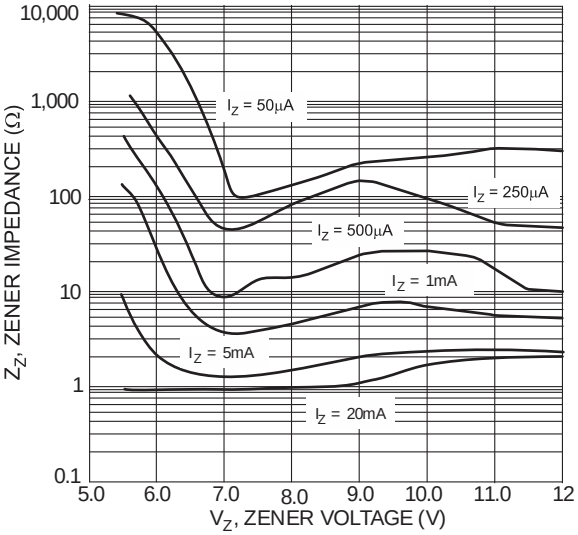


Fig. 7 Typical Zener Impedance Characteristics, DDZ5V6BS - DDZ12CS

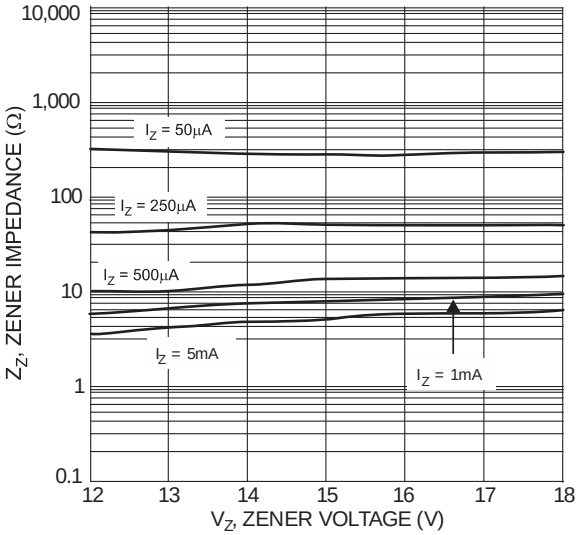


Fig. 8 Typical Zener Impedance Characteristics, DDZ12CS - DDZ18CS

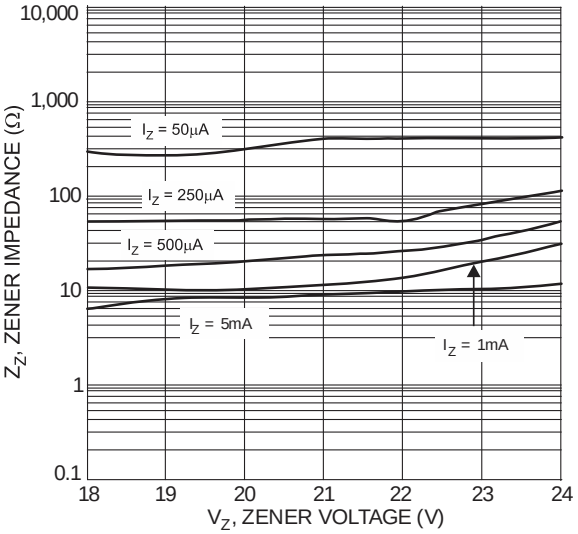


Fig. 9 Typical Zener Impedance Characteristics, DDZ18CS - DDZ24CS

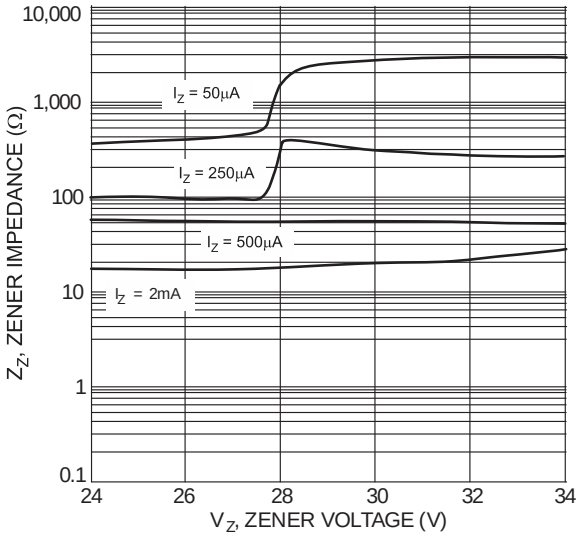


Fig. 10 Typical Zener Impedance Characteristics, DDZ24CS - DDZ33S

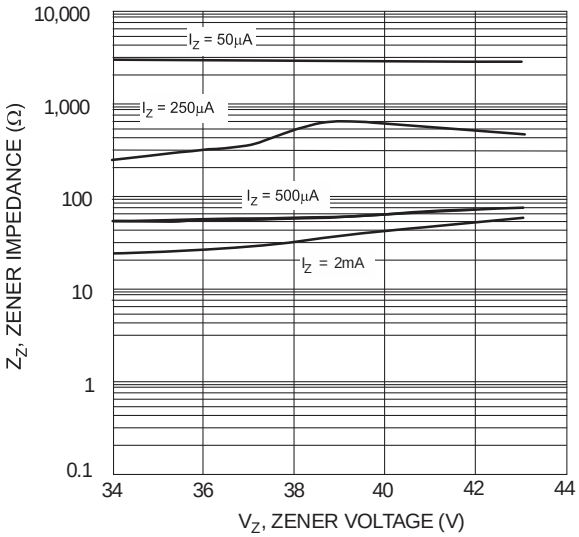


Fig. 11 Typical Zener Impedance Characteristics, DDZ36S - DDZ43S

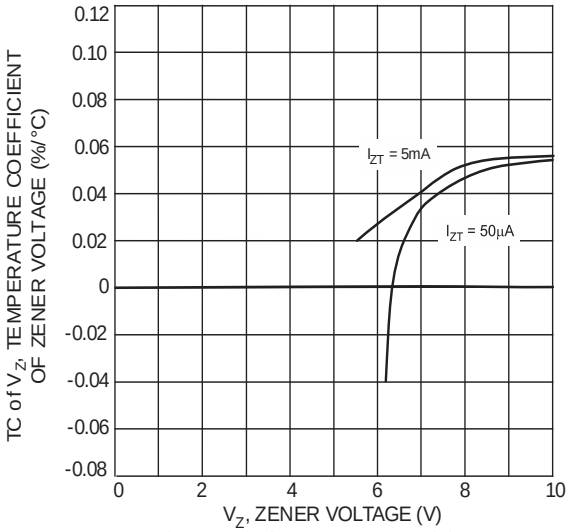


Fig. 12 Typical Temperature Coefficient of Zener Voltage vs. Zener Voltage, DDZ6V2BS-DDZ10CS

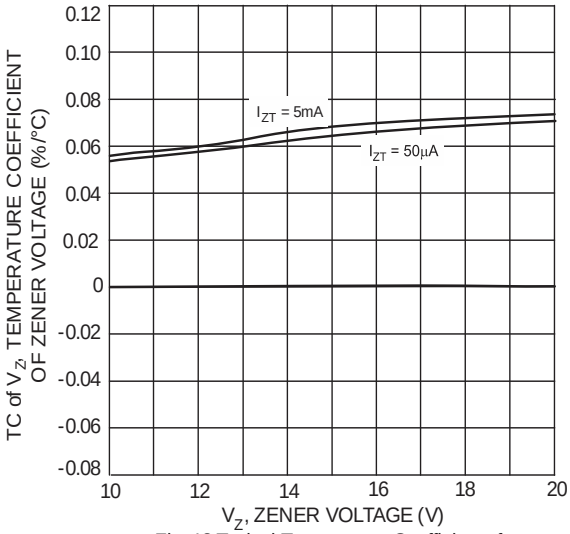


Fig. 13 Typical Temperature Coefficient of Zener Voltage vs. Zener Voltage, DDZ10CS-DDZ20CS

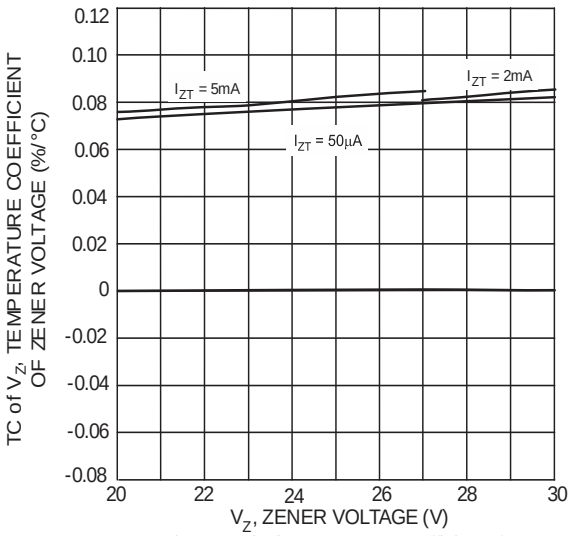


Fig. 14 Typical Temperature Coefficient of Zener Voltage vs. Zener Voltage, DDZ20CS-DDZ30DS

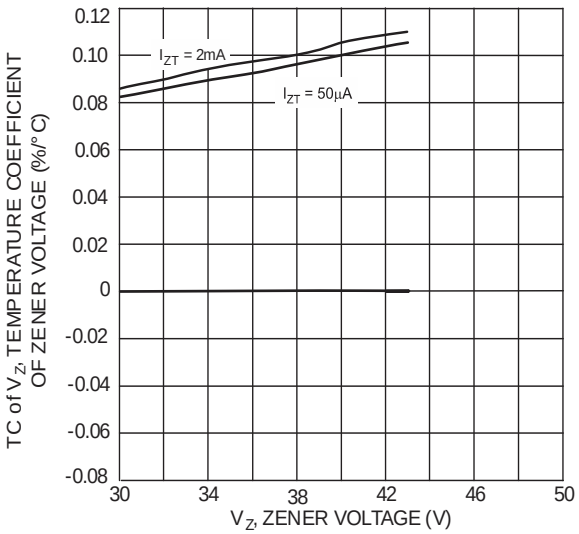
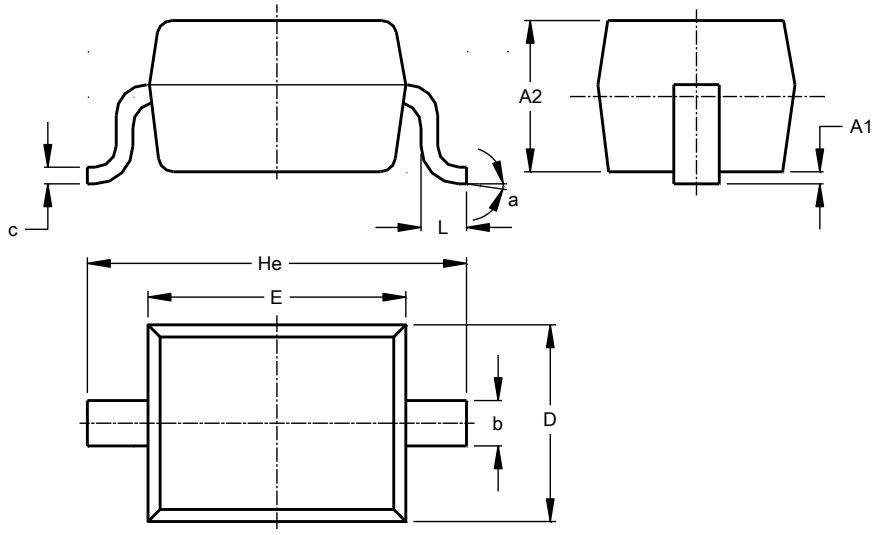


Fig. 15 Typical Temperature Coefficient of Zener Voltage vs. Zener Voltage, DDZ30DS-DDZ43S

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD323

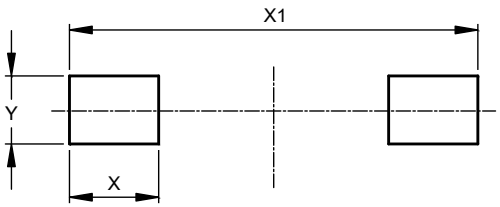


SOD323			
Dim	**Min**	**Max**	**Typ**
A1	--	0.10	0.05
A2	1.00	1.10	1.05
b	0.25	0.35	0.30
c	0.10	0.15	0.11
D	1.20	1.40	1.30
E	1.60	1.80	1.70
He	2.30	2.70	2.50
L	0.20	0.40	0.30
a	0º	8º	--
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD323



Dimensions	Value (in mm)
X	0.590
X1	2.700
Y	0.450

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

www.diodes.com